FDS89141 Dual N-Channel PowerTrench[®] MOSFET 100 V, 3.5 A, 62 m Ω

Features

FAIRCHILD

- Max $r_{DS(on)}$ = 62 m Ω at V_{GS} = 10 V, I_D = 3.5 A
- Max $r_{DS(on)}$ = 100 m Ω at V_{GS} = 6 V, I_D = 2.8 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- RoHS Compliant

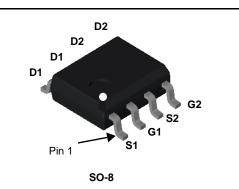


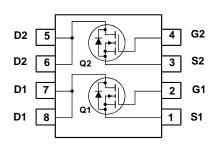
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Synchronous Rectifier
- Primary Switch For Bridge Topology





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage		100	V		
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous			3.5		
D	-Pulsed		18	— A		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	37	mJ	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	31	14/	
	Power Dissipation	(Note 1b)	1.6	W		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	4.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS89141	FDS89141	SO-8	13 "	12 mm	2500 units

December 2010

FDS89141 [
Dual
N-Channel Powe
erTrench [®] I
MOSFET

Off Char	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		69		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3.1	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
		V _{GS} = 10 V, I _D = 3.5 A		47	62	
DS(on)	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 2.8 A		63	100	mΩ
. ,		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$ 81		107	
				447		S
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}$		14.7		3
-	Characteristics	V _{DS} = 10 V, I _D = 3.5 A		14.7		3
Dynamic				299	398	pF
Dynamic C _{iss}	Characteristics	– V _{DS} = 50 V, V _{GS} = 0 V,		1	398 93	
Dynamic C _{iss} C _{oss}	Characteristics			299		pF
Dynamic C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance	– V _{DS} = 50 V, V _{GS} = 0 V,		299 70	93	pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	– V _{DS} = 50 V, V _{GS} = 0 V,		299 70 4.7	93	pF pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g Switchin	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	– V _{DS} = 50 V, V _{GS} = 0 V,		299 70 4.7	93	pF pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g Switchin	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics	V _{DS} = 50 V, V _{GS} = 0 V, f = 1MHz		299 70 4.7 1.0	93 7	pF pF pF Ω
Dynamic C _{iss} C _{oss} C _{rss} R _g Switchin t _{d(on)} t _r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	– V _{DS} = 50 V, V _{GS} = 0 V,		299 70 4.7 1.0	93 7 10	pF pF Ω ns
Dynamic C _{iss} C _{oss} C _{rss} R _g Switchin t _d (on) t _r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1MHz $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 3.5 \text{ A},$		299 70 4.7 1.0 5 1.4	93 7 10 10	pF pF pF Ω ns
Dynamic C _{iss} C _{oss} C _{rss} R _g Switchin t _d t _d (on) t _r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Gate Resistance Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1MHz $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 3.5 \text{ A},$		299 70 4.7 1.0 5 1.4 9.8	93 7 10 10 20	pF pF pF Ω ns ns ns
Dynamic C_{iss} C_{rss} R_g Switchin $t_{d(on)}$ t_r $t_{d(off)}$ t_f $q_{g(TOT)}$	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1MHz $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 3.5 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		299 70 4.7 1.0 5 1.4 9.8 2.2	93 7 10 10 20 10	pF pF pF Ω ns ns ns ns
Dynamic C _{iss} C _{oss} C _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1MHz $V_{DD} = 50 \text{ V}, I_{D} = 3.5 \text{ A},$ V_{GS} = 10 V, R_{GEN} = 6 \Omega		299 70 4.7 1.0 5 1.4 9.8 2.2 5.1	93 7 10 10 20 10 7.1	pF pF Ω ns ns ns ns nc

Test Conditions

Min

Тур

Max

Units

Drain-Source Diode Characteristics

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Parameter

Source to Urain Diode Forward Voltage	Source to Drain Diode, Ferward Voltage	$V_{GS} = 0 V, I_{S} = 3.5 A$	= 3.5 A (Note 2) 0.8	1.3	V	
	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	0.8	1.2	v	
t _{rr}	Reverse Recovery Time	I _E = 3.5 A, di/dt = 100 A/μs		33	53	ns
Q _{rr}	Reverse Recovery Charge	$T_{\rm F} = 5.5 \text{A}, \text{di/dt} = 100 \text{A/}\mu\text{s}$		23	37	nC

NOTES:

Symbol

1. R_{BLA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{BJC} is guaranteed by design while R_{BCA} is determined by the user's board design.



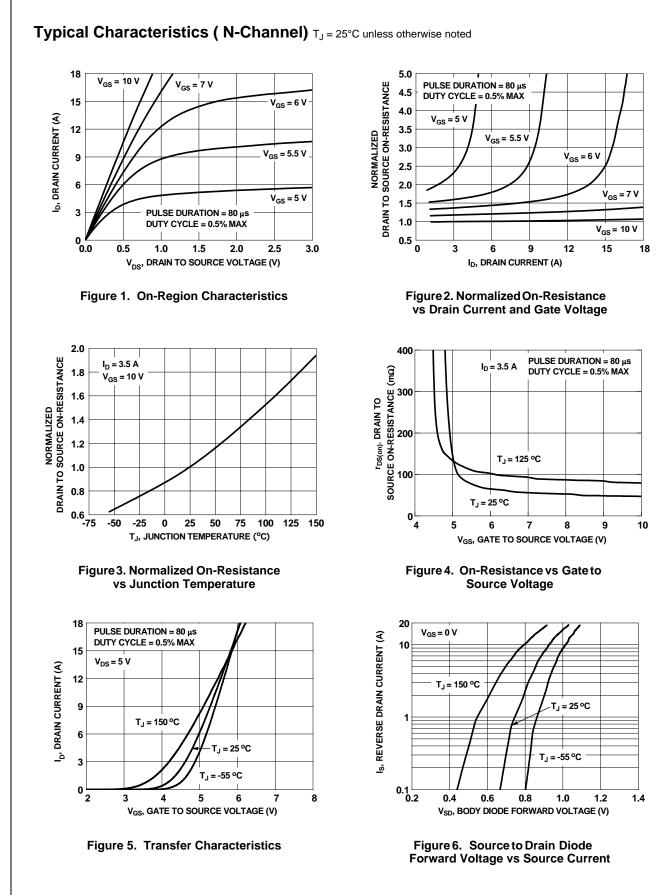
a) 78°C/W when mounted on a 1 in² pad of 2 oz copper



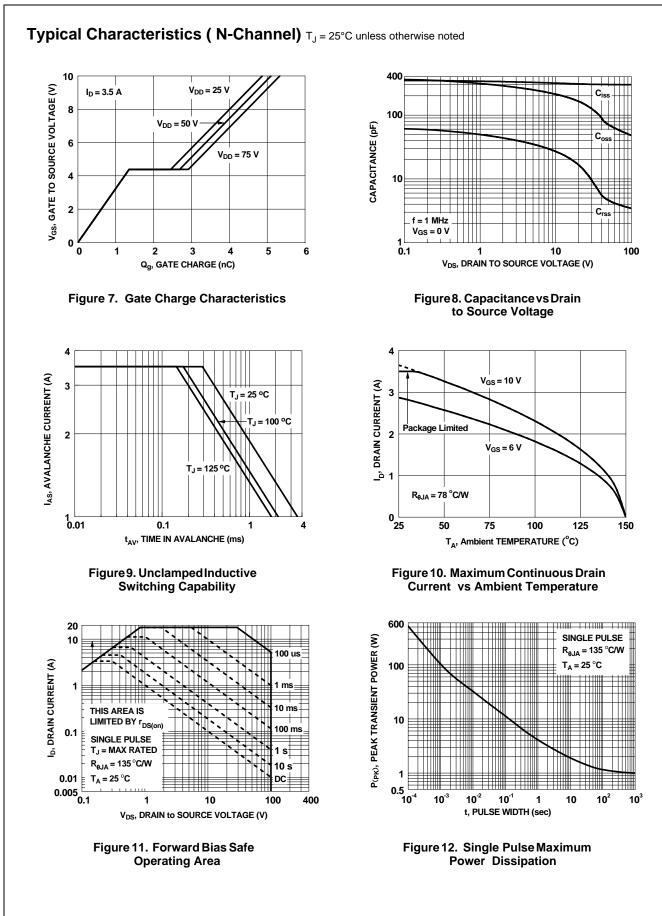
b) 135°C/W when mounted on a minimun pad

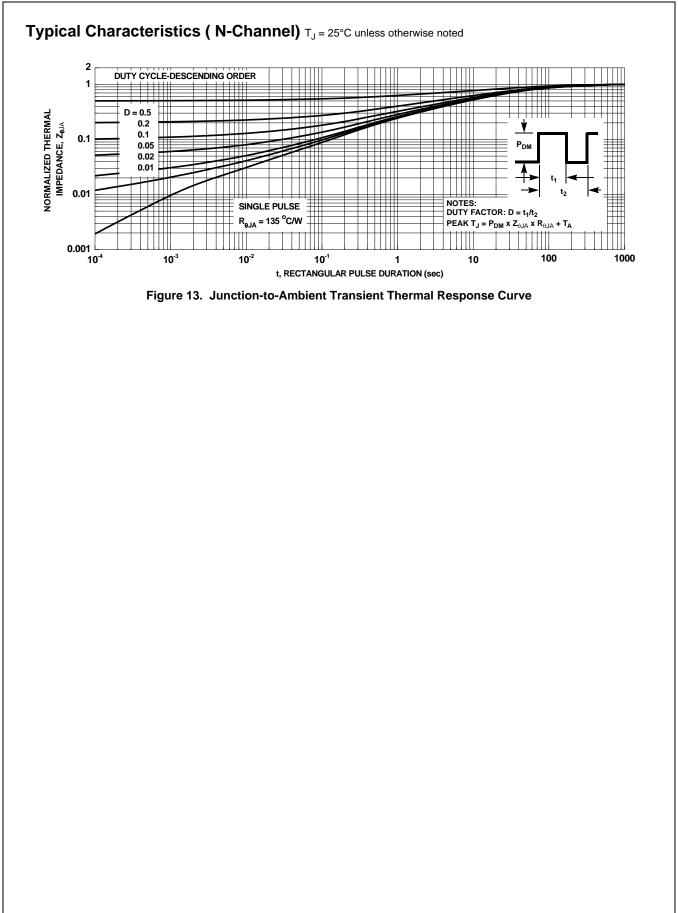
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25°C, L = 3.0 mH, I_{AS} = 5.0 A, V_{DD} = 100 V, V_{GS} = 10V.

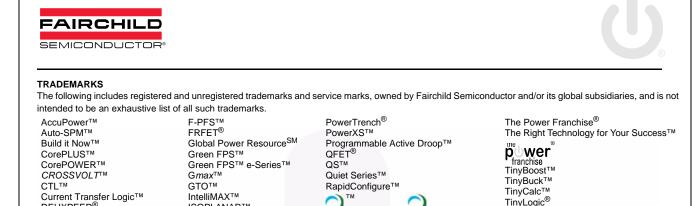












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